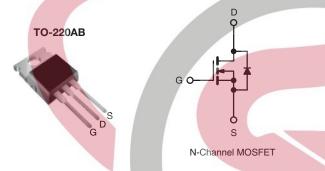


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	400				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.55			
Q _g (Max.) (nC)	63				
Q _{gs} (nC)	9.0				
Q _{gd} (nC)	32				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF740PbF
	SiHF740-E3
SnPb	IRF740
	SiHF740

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)								
PARAMETER		SYMBOL	LIMIT	UNIT				
Drain-Source Voltage		V _{DS}	400	v				
Gate-Source Voltage		V _{GS}	± 20	v				
Continuous Drain Current	$V_{GS} \text{ at } 10 \text{ V} \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	ID	10 6.3	A				
Pulsed Drain Current ^a		I _{DM}	40					
Linear Derating Factor			1.0	W/°C				
Single Pulse Avalanche Energy ^b		E _{AS}	520	mJ				
Repetitive Avalanche Currenta		I _{AR}		A				
Repetitive Avalanche Energy ^a		E _{AR}		🖌 mJ				
Maximum Power Dissipation	T _C = 25 °C	P _D	125	W				
Peak Diode Recovery dV/dt ^c		dV/dt	4.0	V/ns				
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150					
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	°C				
Manatha Tana	0.00		10	lbf ∙ in				
Mounting Torque 6-32 or M3 screw			1.1	N·m				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 9.1 mH, R_g = 25 Ω , I_{AS} = 10 A (see fig. 12).

c. $I_{SD} \leq 10$ A, dl/dt ≤ 120 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RAT	INGS						
PARAMETER	SYMBOL	TYP.	MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62	62			
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-		°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0				
SPECIFICATIONS (T _J = 25 °C, u	inloss othorw	ico potod)					
PARAMETER	SYMBOL		NDITIONS	MIN.	TYP.	MAX.	UNIT
Static	STIVIBOL	1231 CO	NDITIONS	IVIIIN.	TTP.	IVIAA.	UNIT
	Ver	Vec = 0.V	I _D = 250 μA	400		_	V
Drain-Source Breakdown Voltage	V _{DS}		25 °C, I _D = 1 mA	400	0.49	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			-	- 0.49		V/°C
Gate-Source Threshold Voltage	V _{GS(th)}		$I_{\rm D} = 250 \mu {\rm A}$	2.0		4.0	V
Gate-Source Leakage	IGSS		± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25	μA
Drain-Source On-State Resistance	P		$= 0 V, T_{J} = 125 °C$	-	-	250	-
	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 6.0 \text{ A}^{b}$	- 	-	0.55	Ω
Forward Transconductance	9 _{fs}	$V_{\rm DS} = 50$ V	$I_{\rm D} = 6.0 {\rm A}^{\rm b}$	5.8	-	-	S
Dynamic		L W	= 0 V,		1 100		1
Input Capacitance	C _{iss}			-	1400	-	_
Output Capacitance	C _{oss}		= 25 V,	-	330	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	120	-	
Total Gate Charge	Qg		_D = 10 A, V _{DS} = 320 V,	<u> </u>	-	63	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	see fig. 6 and 13 ^b	-	-	9.0	nC
Gate-Drain Charge	Q _{gd}		see lig. o and to	-	-	32	
Turn-On Delay Time	t _{d(on)}			-	14	-	
Rise Time	tr	$V_{DD} = 200 \text{ V}, I_{D} = 10 \text{ A}$		-	27	-	ns
Turn-Off Delay Time	t _{d(off)}	R_g = 9.1 Ω , R_D = 20 Ω , see fig. 10 ^b		-	50	-	
Fall Time	t _f			-	24	-	
Internal Drain Inductance	LD	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5		
Internal Source Inductance	L _S			-	7.5	-	nH
Drain-Source Body Diode Characteristi	cs		EOTI				•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol	EG	1 U	Ą	10	
Pulsed Diode Forward Current ^a	I _{SM}	showing the integral reverse p - n junction diode		-	-	40	A
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S =	10 A, V _{GS} = 0 V ^b	-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	$T_{\rm J} = 25 \text{ °C}, I_{\rm F} = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu \text{s}^{\rm b}$		-	370	790	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	3.8	8.2	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on	time is negligible (turn	i-on is dor	ninated b	y L _S and	L _D)

Notes

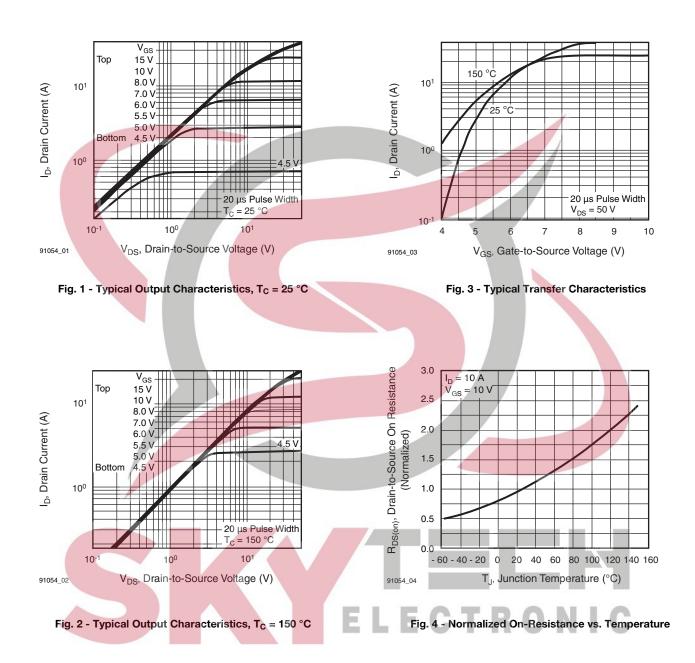
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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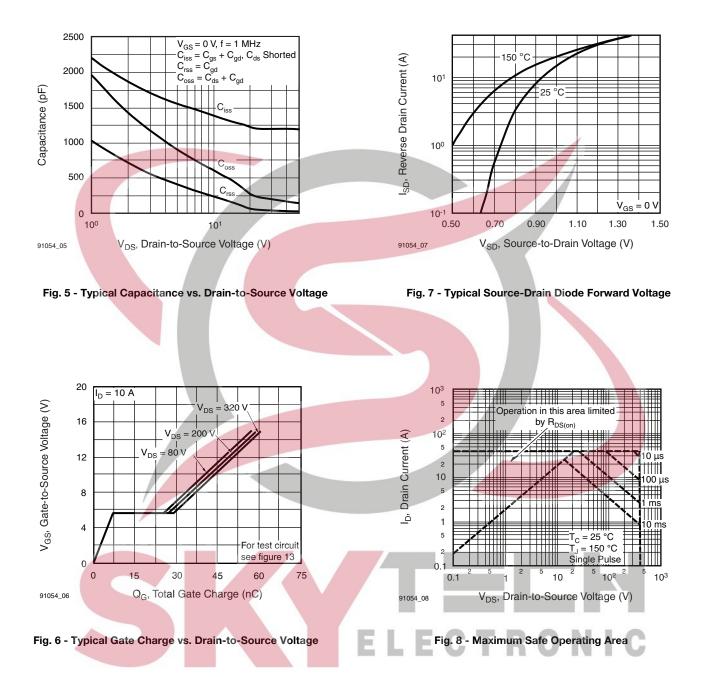


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

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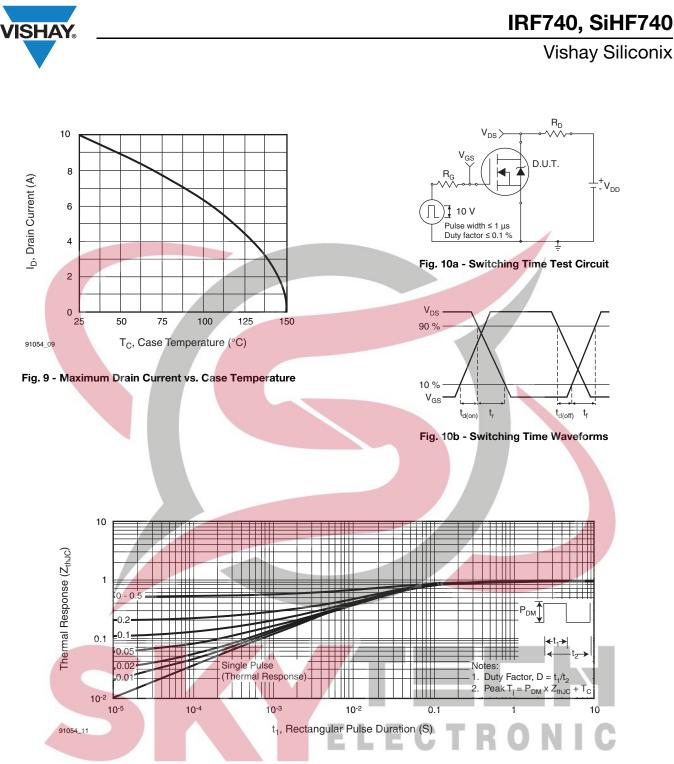


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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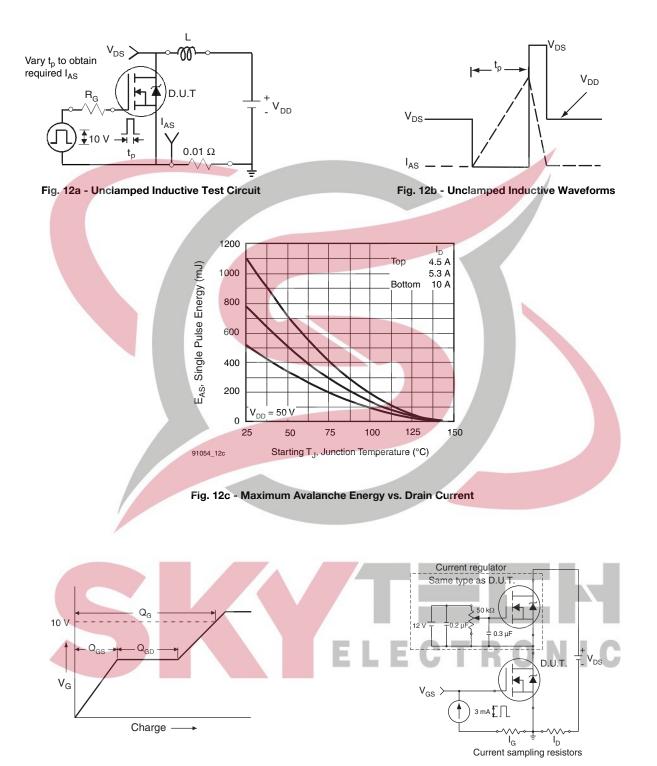


Fig. 13a - Basic Gate Charge Waveform

Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

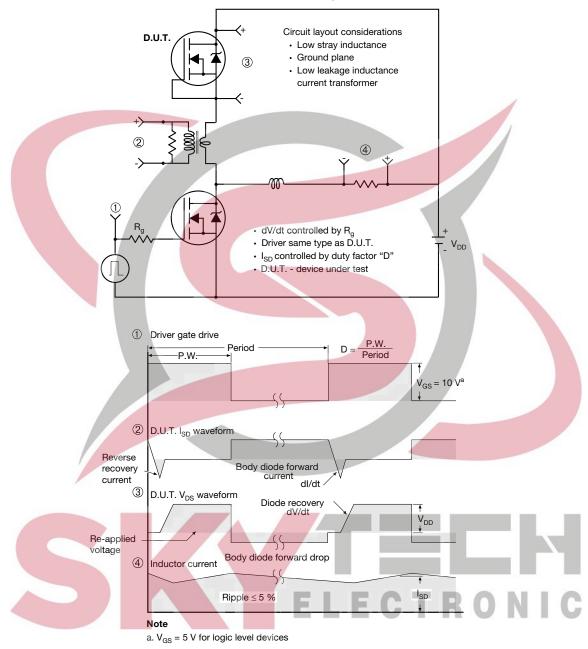


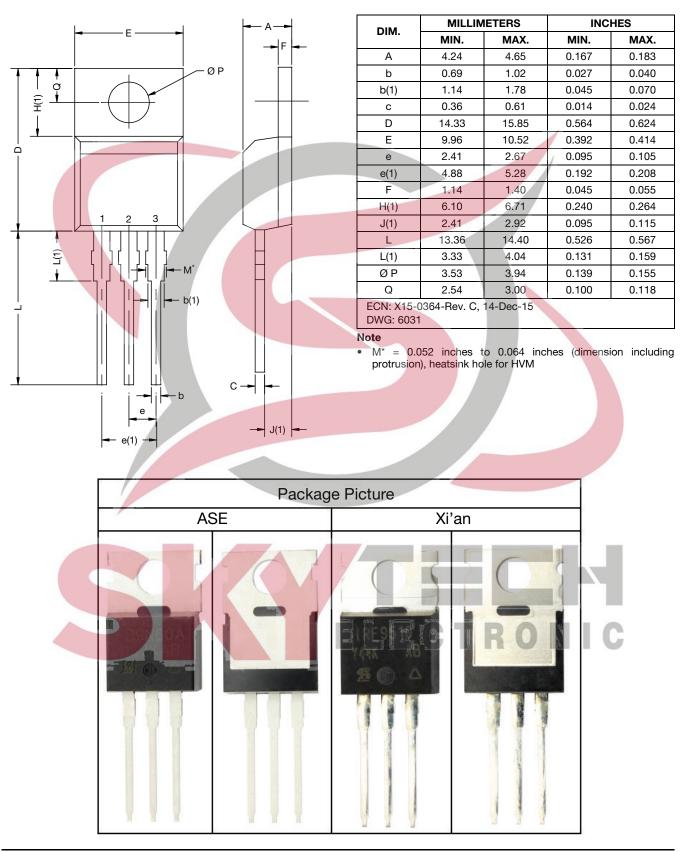
Fig. 14 - For N-Channel

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TO-220-1



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30

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